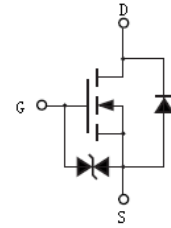


Features

- Low power loss by high speed switching and low on-resistance
- Excellent thermal behavior
- Very low FOM for fast switching efficiency
- Integrated ESD protection diode: HBM: JESD22-A114-B: 3A
- RoHS compliant with Halogen-free

HF

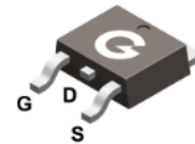


Applications

- PFC power supply stages
- Lighting applications
- Adapter

Mechanical Data

- Case: TO-252
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208



TO-252

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
SJM80R850D	TO-252	80 pcs / Tube & 2500 pcs / Tape & Reel	SJM80R850D

Maximum Ratings (@ T_C = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V _{DSS}	800	V
Gate-to-Source Voltage (Static)	V _{GSS}	±20	V
Continuous Drain Current (T _C = 25°C)	I _D	6.5	A
Continuous Drain Current (T _C = 100°C)		4.1	A
Pulsed Drain Current (t _p = 10μs, T _C = 25°C)	I _{DM}	26	A
Single Pulse Avalanche Energy ^{*3}	E _{AS}	120	mJ
Power Dissipation (T _C = 25°C)	P _D	63	W
Operating Junction Temperature Range	T _J	-55 ~ +150	°C
Storage Temperature Range	T _{STG}	-55 ~ +150	°C

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance Junction-to-Case	R _{θJC}	-	1.4	2	°C/W
Thermal Resistance Junction-to-Air ^{*1}	R _{θJA}	-	50	62	°C/W

Electrical Characteristics (@ T_A = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	800	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 800V, V _{GS} = 0V	-	-	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V, V _{DS} = 0V	-	-	±1	μA
On Characteristics						
R _{DS(ON)}	Drain-Source On-resistance *2	V _{GS} = 10V, I _D = 1.5A	-	0.68	0.85	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2	3.2	4	V
R _G	Gate Resistance	V _{GS} = 0V, f = 1MHz	-	7	-	Ω
Dynamic Characteristics						
C _{ISS}	Input Capacitance	V _{GS} = 0V	-	601	-	pF
C _{OSS}	Output Capacitance	V _{DS} = 40V	-	54	-	
C _{RSS}	Reverse Transfer Capacitance	f = 250kHz	-	2.4	-	
Switching Characteristics						
t _{d(ON)}	Turn-on Delay Time *4	V _{DD} = 400V I _D = 2.8A R _G = 25Ω	-	23	-	ns
t _r	Turn-on Rise Time *4		-	18	-	
t _{d(OFF)}	Turn-Off Delay Time *4		-	74	-	
t _f	Turn-Off Fall Time *4		-	17	-	
Q _G	Total Gate-Charge	V _{DD} = 640V	-	17	-	nC
Q _{GS}	Gate to Source Charge	V _{GS} = 10V	-	3	-	
Q _{GD}	Gate to Drain (Miller) Charge	I _D = 3A	-	8.4	-	
Source-Drain Diode Characteristics						
V _{SD}	Diode Forward Voltage *2	I _{SD} = 3A, V _{GS} = 0V	-	0.85	1.3	V
t _{rr}	Reverse Recovery Time	I _F = 1A, V _R = 400V	-	190	-	ns
Q _{rr}	Reverse Recovery Charge	di/dt = 100A/μs	-	1	-	μC

Notes:

1. The data tested by surface mounted on a minimum recommended FR-4 board
2. The data tested by pulsed, pulse width ≤ 300μs, duty cycle ≤ 2%
3. The E_{AS} data shows Max. rating. The test condition is V_{DD} = 100V, V_{GS} = 10V, L = 50mH
4. Guaranteed by design, not subject to production

Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

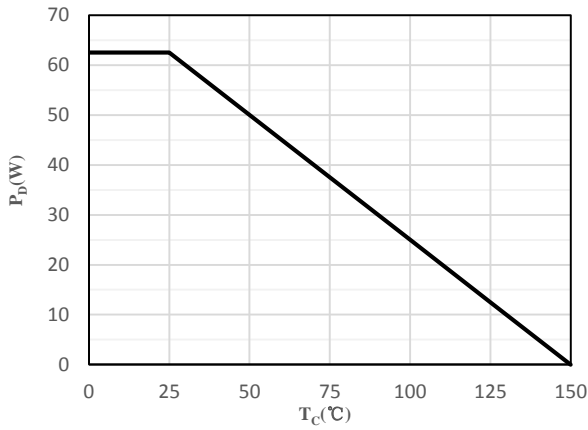


Fig 1 Power Dissipation

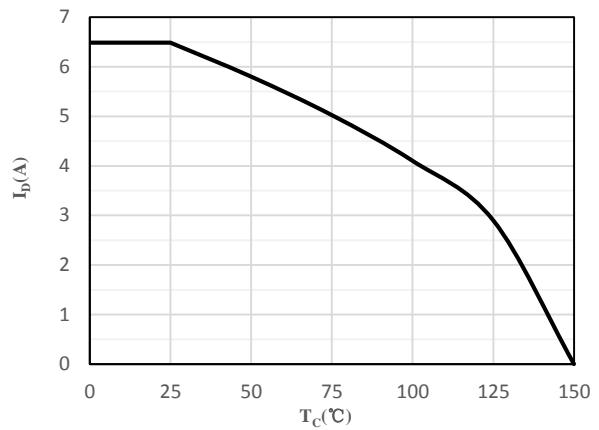


Fig 2 Drain Current



Fig 3 Typical Output Characteristics

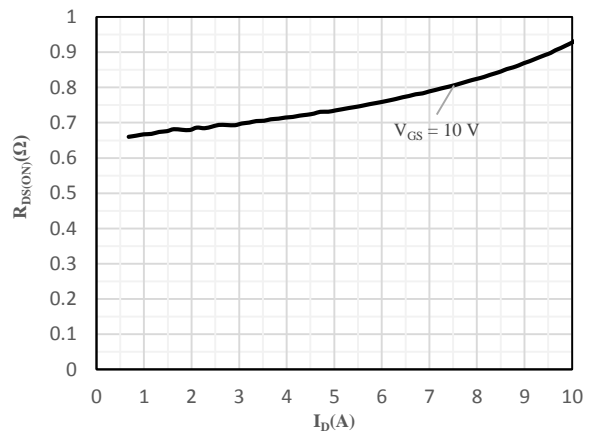


Fig 4 On-Resistance vs. Drain Current and Gate Voltage

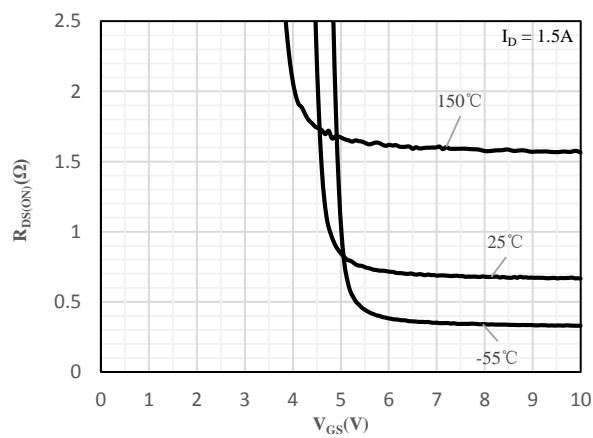


Fig 5 On-Resistance vs. Gate-Source Voltage

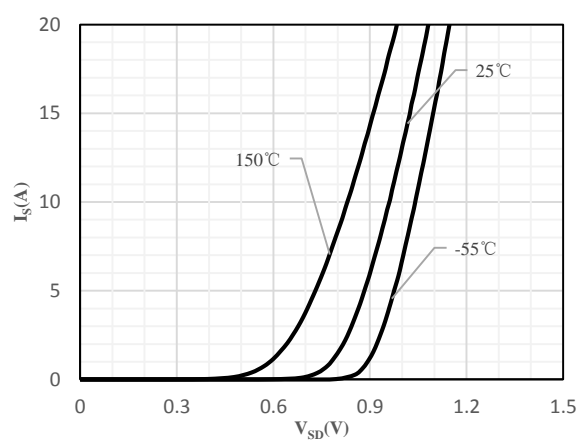


Fig 6 Body-Diode Characteristics

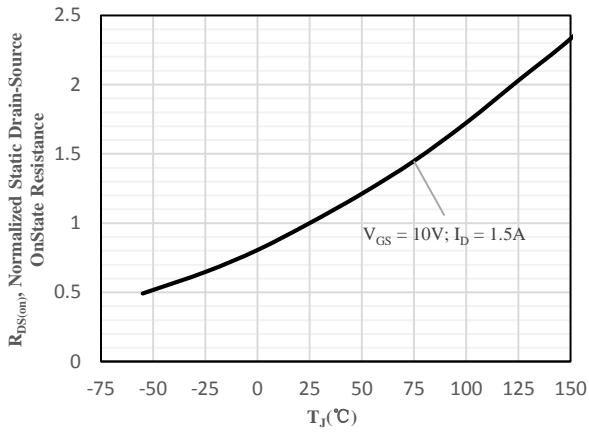


Fig 7 Normalized On-Resistance vs. Junction Temperature

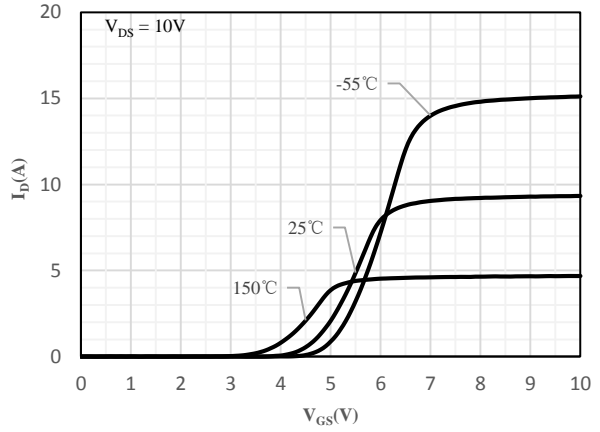


Fig 8 Transfer Characteristics

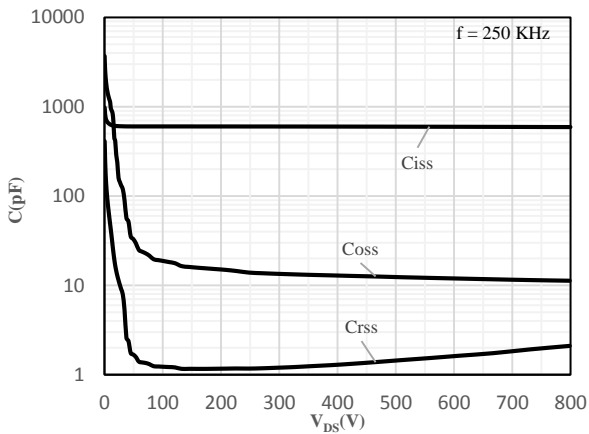


Fig 9 Capacitance Characteristics

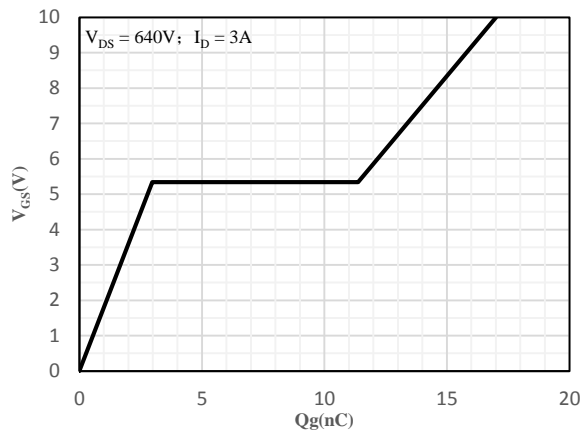


Fig 10 Gate-Charge Characteristics

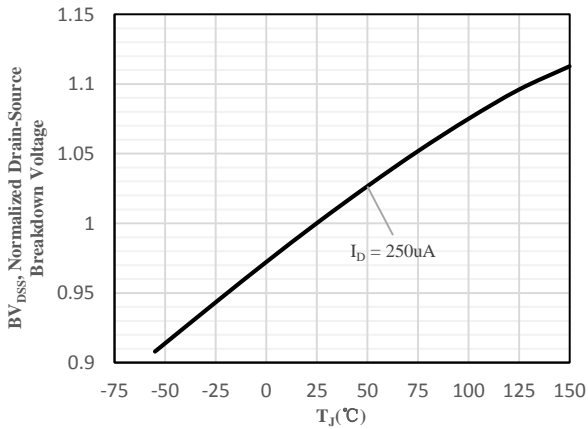


Fig 11 Normalized Breakdown Voltage vs. Junction Temperature

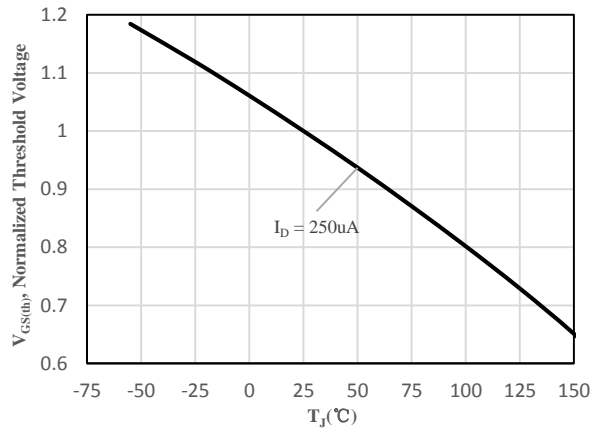


Fig 12 Normalized $V_{GS(th)}$ vs. Junction Temperature

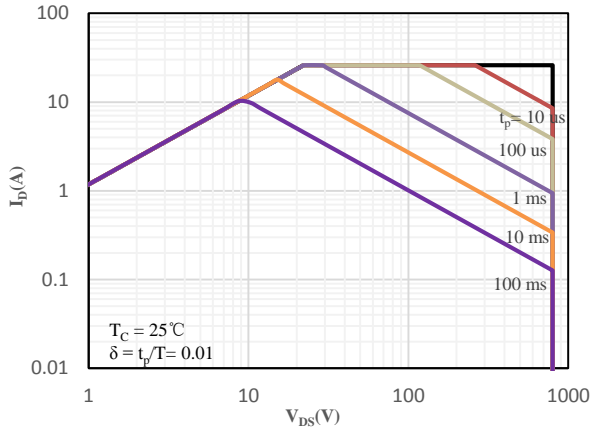


Fig 13 Safe Operation Area

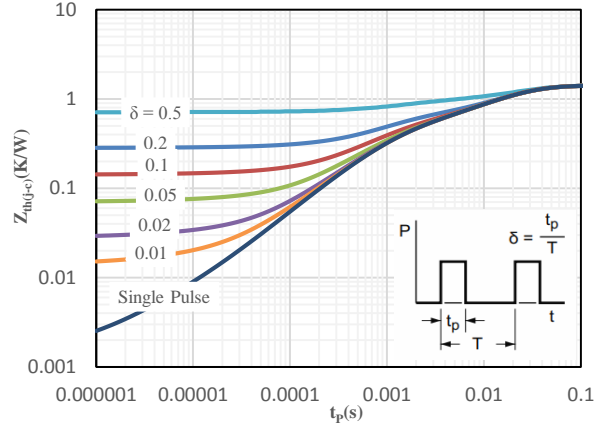
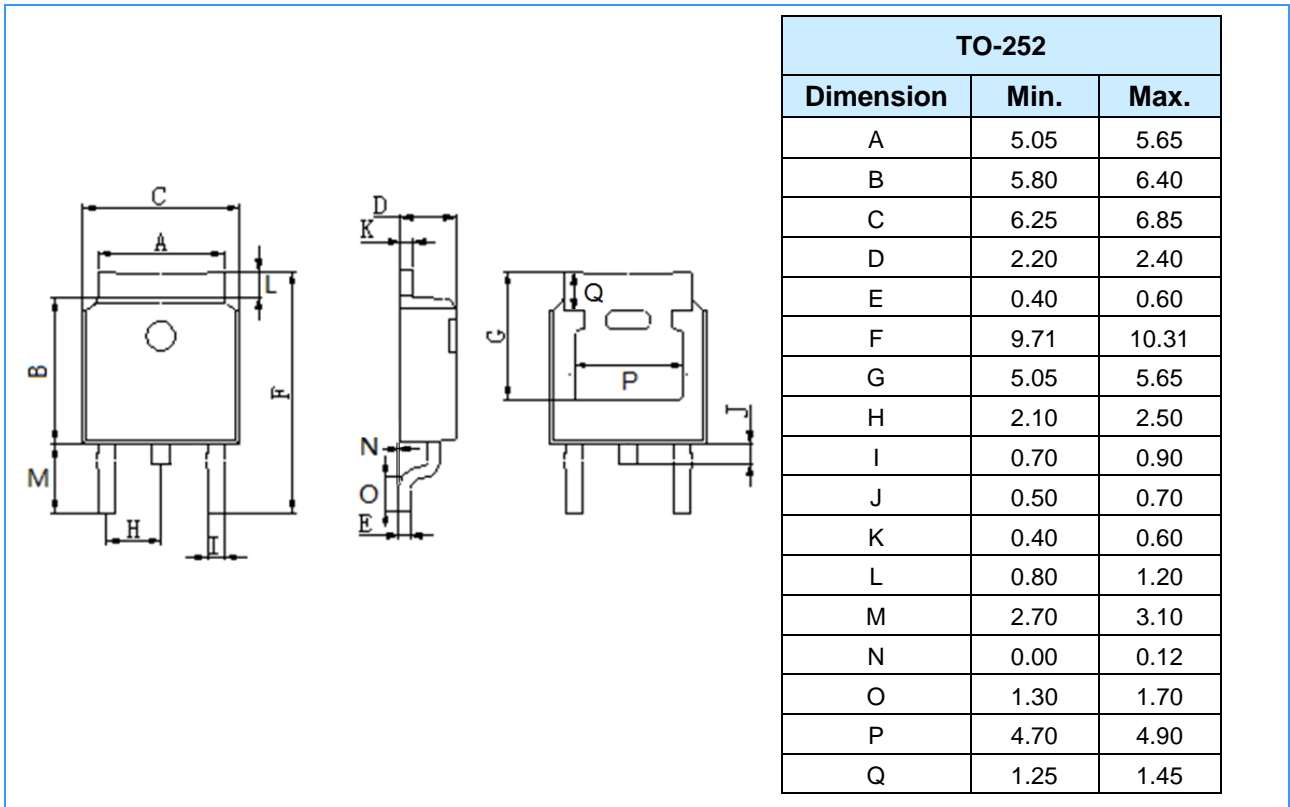


Fig 14 Maximum transient thermal impedance

Package Outline Dimensions (Unit: mm)



Mounting Pad Layout (Unit: mm)

